



Docket No.: M4065.0127/P127-A  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Kie Y. Ahn, et al.

Application No.: 09/660,324

Group Art Unit: 2823

Filed: September 12, 2000

Examiner: E. Toledo

For: SILICON MULTI-CHIP MODULE  
PACKAGING WITH INTEGRATED  
PASSIVE COMPONENTS AND METHOD  
OF MAKING

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**STATEMENT OF COMMON OWNERSHIP**

Commissioner for Patents  
Washington, DC 20231

Dear Sir:

The present Application, numbered 09/660,324, and U.S. Patent No. 6,201,287 B1 (Forbes) describe and claim subject matter which, at the time the invention of Application 09/660,324 was made, was commonly owned by Micron Technology Inc., Boise ID.

Dated: October 26, 2001

Respectfully submitted,

By 

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2823

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PTO/SB/21 (08-00)  
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<b>TRANSMITTAL FORM</b>  (to be used for all correspondence after initial filing)	<b>Application Number</b>	09/660,324	
	<b>Filing Date</b>	September 12, 2000	
	<b>First Named Inventor</b>	Kie Y. Ahn	
	<b>Group Art Unit</b>	2823	
	<b>Examiner Name</b>	F. Toledo	
<b>Total Number of Pages in This Submission</b>		<b>Attorney Docket Number</b>	M4065.0127/P127-A

ENCLOSURES (check all that apply)		
<input type="checkbox"/> Fee Transmittal Form  <input type="checkbox"/> Fee Attached  <input checked="" type="checkbox"/> Amendment/Reply  <input checked="" type="checkbox"/> After Final  <input type="checkbox"/> Affidavits/declaration(s)  <input type="checkbox"/> Extension of Time Request  <input type="checkbox"/> Express Abandonment Request  <input type="checkbox"/> Information Disclosure Statement  <input type="checkbox"/> Certified Copy of Priority Document(s)  <input type="checkbox"/> Response to Missing Parts/Incomplete Application  <input type="checkbox"/> Response to Missing Parts under 37 CFR 1.52 or 1.53	<input type="checkbox"/> Assignment Papers (for an Application)  <input type="checkbox"/> Drawing(s)  <input type="checkbox"/> Licensing-related Papers  <input type="checkbox"/> Petition  <input type="checkbox"/> Petition to Convert to a Provisional Application  <input type="checkbox"/> Power of Attorney, Revocation Change of Correspondence Address  <input type="checkbox"/> Terminal Disclaimer  <input type="checkbox"/> Request for Refund  <input type="checkbox"/> CD, Number of CD(s) _____	<input type="checkbox"/> After Allowance Communication to Group  <input type="checkbox"/> Appeal Communication to Board of Appeals and Interferences  <input type="checkbox"/> Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)  <input type="checkbox"/> Proprietary Information  <input type="checkbox"/> Status Letter  <input type="checkbox"/> Other Enclosure(s) (please identify below)
<b>Remarks</b>		

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SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT	
<b>Firm or Individual Name</b>	DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP Thomas J. D'Amico
<b>Signature</b>	
<b>Date</b>	October 26, 2001

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